# EVERLIGHT ELECTRONICS CO.,LTD.

#### **Technical Data Sheet**

# Chip LED with Bi-Color (Multi-Color)

#### 19-22/R6BHC-B01/2T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Multi-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

#### **Descriptions**

- The 19-22 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Applications**

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

#### **Device Selection Guide**

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Chip			Long Colon	
Туре	Material	<b>Emitted Color</b>	Lens Color	
R6	AlGaInP	Brilliant Red	W. Cl	
ВН	InGaN	Blue	Water Clear	

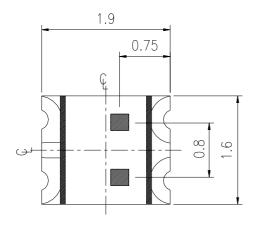
Device No.: DSE-192-B02 Prepared date: 26-Sep-2005 Prepared by:Jeff Tsai

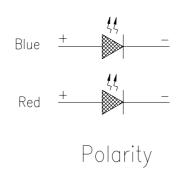
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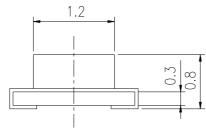
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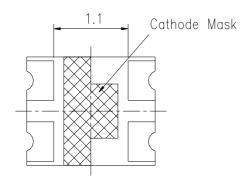
# **Package Outline Dimensions**

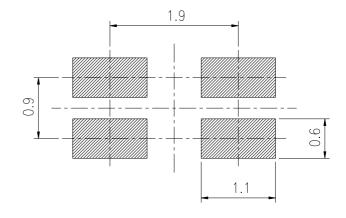












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**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

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# **Absolute Maximum Ratings (Ta=25℃)**

Parameter	Symbol	Rating	Unit	
Reverse Voltage	$V_R$	5	V	
Forward Current	${ m I}_{ m F}$	R6:25 BH:25	mA	
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	Tsol	260 (for 5 second)	${\mathbb C}$	
Electrostatic Discharge(HBM)	ESD	R6:2000 BH:150	V	
Power Dissipation	Pd	R6:60 BH:110	mW	
Peak Forward Current (Duty 1/10 @1KHz)	IFP	R6:60 BH:100	mA	
Soldering Temperature	Tsol	Reflow Soldering : 260 °C for 10 sec. Hand Soldering : 350 °C for 3 sec.		

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# **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol		Min.	Typ.	Max.	Unit	Condition	
	Iv	R6	14.5	20.0		1		
Luminous Intensity		ВН	14.5	20.0		mcd		
Viewing Angle	$2\theta$	1/2		120		deg		
Peak Wavelength	λр	R6		632		nm	IF=5mA	
		ВН		468				
D : (W 1 1	λр	R6	617.5 467.5		629.5	nm		
Dominant Wavelength		ВН			472.5			
Spectrum Radiation	Δλ	R6		20				
Bandwidth		ВН		35		nm		
Forward Voltage	VF	R6		1.9	2.3	V		
		ВН		2.9	3.3	•		
Daviaga Chamarit	IR	R6			10	A	Vn-5V	
Reverse Current		ВН			50	$\mu$ A	V <sub>R</sub> =5V	

#### **Notes:**

- 1.Tolerance of Luminous Intensity ±10%
- 2. Tolerance of Dominant Wavelength  $\pm 1$ nm

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**R6 Bin Range Of Dom. Wavelength** 

Bin	Min	Max	Unit	Condition
1	617.5	621.5		
2	621.5	625.5	nm	IF=5mA
3	625.5	629.5		

# **BH Bin Range Of Dom. Wavelength**

Bin	Min	Max	Unit	Condition
2	467.5	470.0		T
3	470.0	472.5	nm	IF=5mA

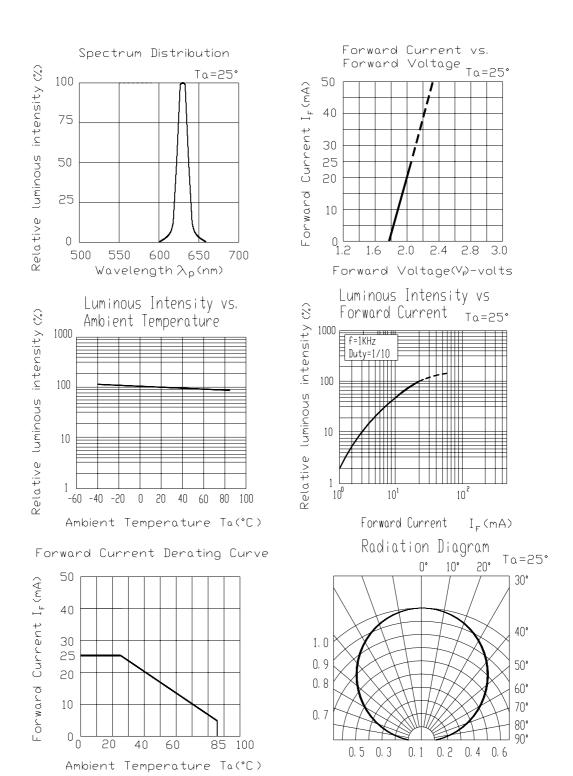
Note: Tolerance of Dominant Wavelength ±1nm

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#### **Typical Electro-Optical Characteristics Curves**

#### **R6**



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80°

0.2

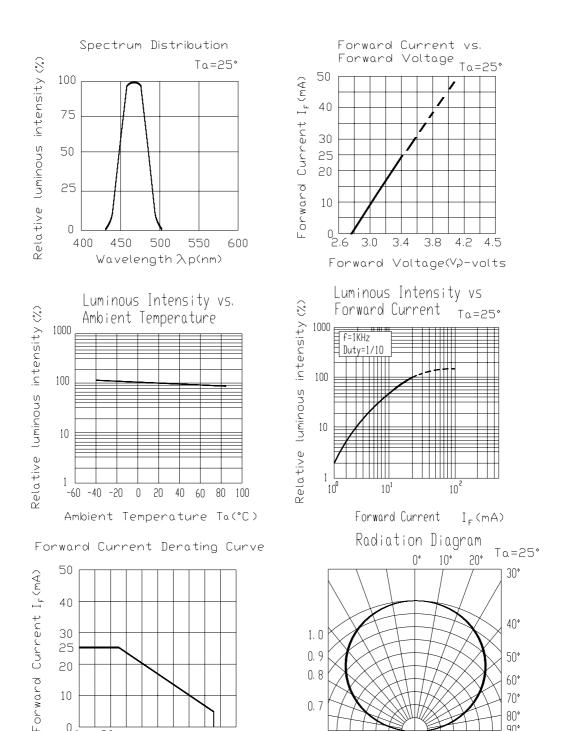
0.1

0.3

0.4

#### **Typical Electro-Optical Characteristics Curves**

#### BH



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85 100

Ambient Temperature Ta(°C)

#### Label explanation

**CAT: Luminous Intensity Rank** 

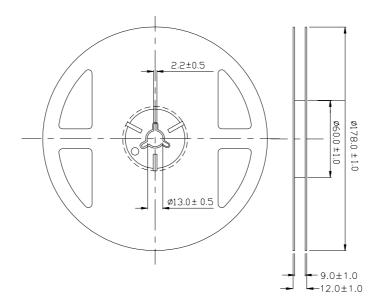
**HUE: Dom. Wavelength Rank** 

**REF: Forward Voltage Rank** 



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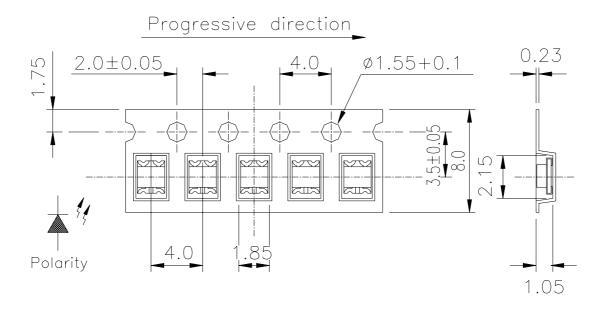
#### **Reel Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

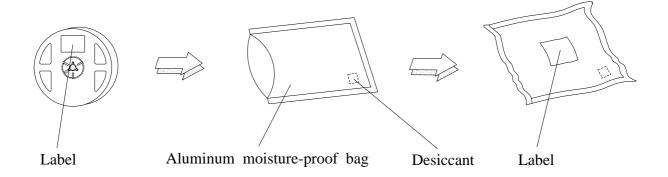
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#### Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm, Unit = mm

#### **Moisture Resistant Packaging**



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#### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100°C	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°€	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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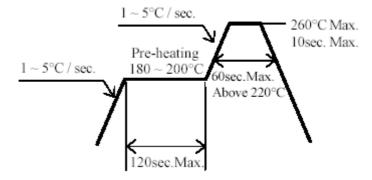
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#### **Precautions For Use**

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30 deg C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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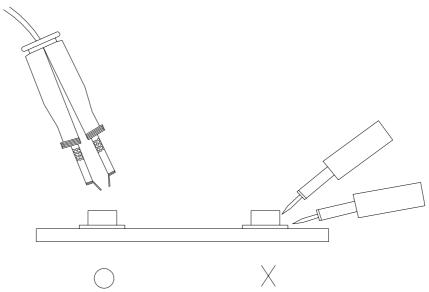


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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